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States Postal Service "Express Mail to Addressee" service under 37 C.F.R. 1.10 on the date indicated above and is addressed to the Commissioner of Patents and Trademarks, Washington, D.C. 202.

**PATENT** 

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of: Neumayr et al.

PCT Application No.: PCT/EP98/05030

Group Art Unit:

Filed: 07 August 1998 (Priority Date - 07 August 1997)

Docket No.: 1328/3

For: PROCESS TO MANUFACTURE A CELLULOSE FIBRE FROM HYDRATE CELLULOSE

## INFORMATION DISCLOSURE STATEMENT

Honorable Commissioner of Patents and Trademarks BOX PCT Washington, D.C. 20231

Sir:

In accordance with 37 C.F.R. 1.56, 1.97, and 1.98, applicants' undersigned attorney brings to the attention of the Patent and Trademark Office the following references. Copies of the references as well as Forms PTO/SB/08A and PTO/SB/08B are attached hereto. This is not to be construed as a representation that a search has been made or that a reference is relevant merely because cited.

U.S. Patent No. 2,046,670 to Beattey.

EP Patent Application No. 0 574 762 A1 to Theis et al.

GB Patent Specification No. 757,233 to Smith et al.

GB Patent Specification No. 133,047.

GB Patent Specification No. 369,912.

GB Patent Specification No. 761,511.

German Patent Application No. DE 298 01 027 U1 to Barthels.

Publication by <u>Serebryzkova et al.</u> entitled "Surfactants and Modifiers in Production of Viscose Fibres (Review)", <u>Fibre Chemistry</u>, Vol. 28, No. 2, (1996) pp. 91-94.

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Database WPI Section Ch, week 9101, Derwent Publications Ltd., London, GB,

Class A18, AN 91-002394 XP002086973 & JP 02 277846 A.

Early passage of the subject application to issue is earnestly solicited.

Respectfully submitted,

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Enclosures